



Micro Autonomous Systems and Technology (MAST) Collaborative Technology Alliance:

Platform Integration

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Outline

Technical Area: Platform Integration

- Vision
- Challenges
- Example Research Issues
- Summary



Technical Area: Platform Integration

**Understand and exploit
the inter-platform and intra-platform
interactions and efficiencies
in a collaborative ensemble of microsystems
to enable operational capabilities.**



- **Integration and experimentation are the keystone for generating empirical data, providing feedback to other Principal Members, and insuring the design process is iterative**
- **Radical design and engineering methodologies are envisioned in which system-level performance is emphasized over the optimization of individual functions**

**The Principal Member for Integration
has primary responsibility for
articulating and executing
a vision on cross-Consortium integration.**



Example Research Topics

Micro Autonomous Systems and Technology

Microsystem Mechanics

- Platform stability & control
- Low Reynolds number aerodynamics
- Bio-inspired sub-systems
- Propulsion and linear actuation
- .
- .
- .

Processing for Autonomous Operation

- Autonomous navigation and control
- Efficient information extraction and utilization
- Dynamic collaborative processing
- Cross-layer communications and network design
- .
- .
- .

Microelectronics

- 3D materials and circuit architectures
- Sensors and actuators for platform and payload
- Smart, multifunctional materials
- Low power devices and small electric power management
- .
- .
- .

Platform Integration

- Microsystem architectures, modeling, and design tools
- Experimentation and analysis
- Sub-system interactions
- Multi-functional packaging
- .
- .
- .



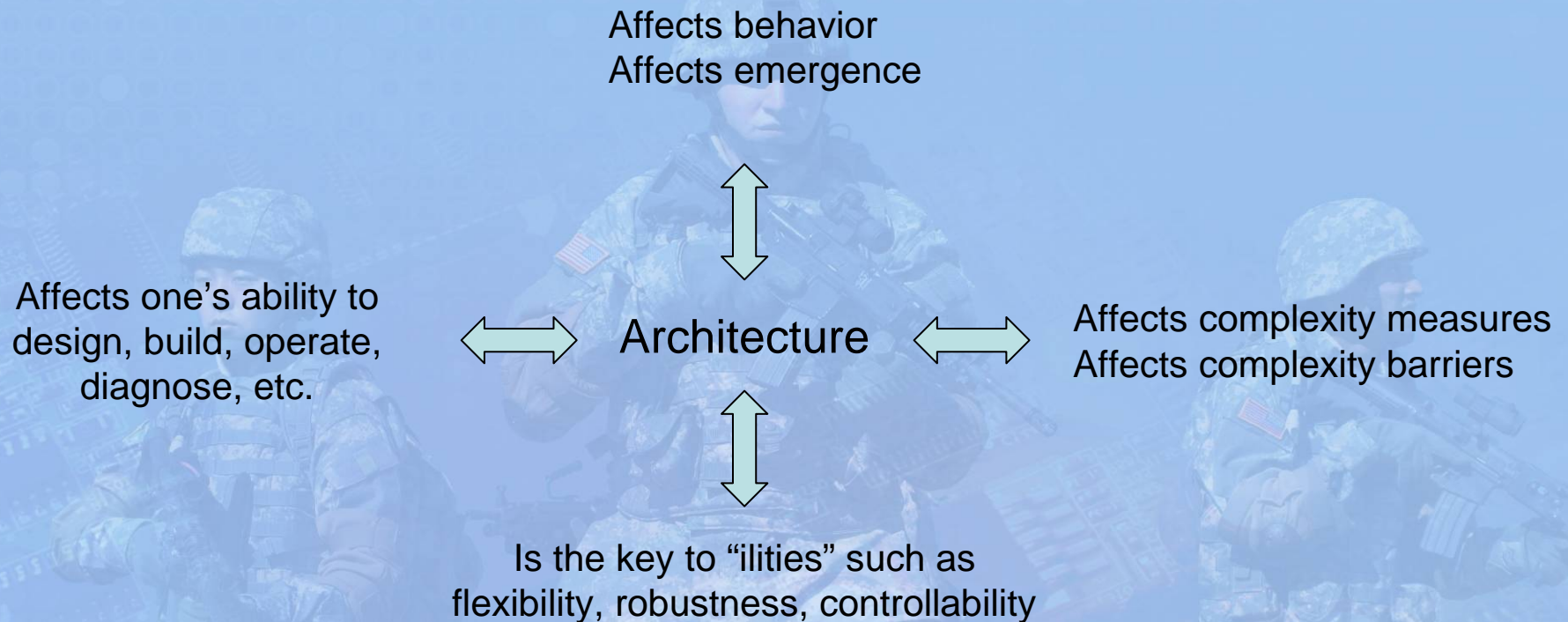
Technical Area: Platform Integration

- **Model, analyze, and simulate system performance**
- **Develop tools to design individual microsystem platforms and specify the collection of platforms necessary to achieve operational capabilities**
- **Study efficiencies that may be obtained through the integration of associated microsystem-related disciplines**
- **Integrate component technologies from Centers**
- **Collect empirical data, and validate platform and system operation through experiment**



The Impact of Architecture

Technical Area: Platform Integration





Architectural Challenges

Technical Area: Platform Integration

- **Balancing traditional against non-traditional engineering goals**
 - e.g., function, performance, cost vs. flexibility, robustness, scalability, controllability, programmability, sustainability
- **Determining the relationships between goals, characteristics, and structure**
 - Relationships or trade-offs are often the fundamental issues
 - e.g., performance vs. flexibility trade-offs
- **Managing complexity, uncertainty, emergence**



- **Determine fundamental physical limits**
- **Define parametric representations of systems and subsystems**
- **Model system and subsystem interactions**
- **Develop design tools to examine tradeoffs**
- **Develop scalable system design**

Platform size, weight, and power dictate solutions that are not scaled versions of large platforms.



Experimental Challenges

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- **Integrating disparate technologies on a single platform**
- **Designing reliable experiments to validate parametric representations and models, and test assumptions on single and multiple platforms**
- **Analysis of empirical data to validate parametric representations and model**



Technical Area: Platform Integration

- **Balancing modularity against integration**
 - Needs and priorities for integration should be guided by anticipated gains in mission capabilities and should outweigh benefits gained through modularity
 - e.g., special purpose platform vs. plug-and-play payload
- **Balancing multifunctionality against single function performance**
- **Controlling negative effects of high density, heterogeneous integration**



Example Research

Technical Area: Platform Integration

- **Efficient structural shapes, materials, and multi-functional designs**
 - Functional packaging
 - Multifunctionality structures
- **Sub-system interactions**
 - Thermal management



Technical Area: Platform Integration

- **Integration across the Consortium**
- Develop tools to design individual microsystem platforms and to specify the collection of platforms necessary to achieve operational capabilities
- Validate platform and system operation through experiment
- Study efficiencies that may be obtained through the integration of associated microsystem-related disciplines such as functional packaging, multi-functional structures and materials, and sub-system interactions